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## IN THE SPECIFICATION:

On page 5 please replace [0003] paragraph with the following paragraph:

As described above, the thicknesses of the protecting films on the front and back side surfaces are preferably different from each other. The protecting film having a larger thickness is volume-shrunk to a greater degree that the protecting film having a smaller thickness, such that the vibrating plate is warped to be concave on the thicker protecting film side. That is, by setting the thickness of the back-side protecting film to be larger than that of the front-side protecting film, the shrink-stress of the back-side protecting film greater than that of the back front-side protecting film, and thus, the piezoelectric vibrating plate is warped on the upper side.